

Part Number: 462071008

Product Description: 4.20mm Pitch, Mini-Fit Jr. Reflow Solder Capable Header, Dual Row, Vertical, 8 Circuits, 1.57mm PCB Thickness, without PCB Pegs, LCP Housing, with Tin (Sn) Over Nickel (Ni) Plating, Glow-Wire Capable,

Tray

Series Number: 46207

Status: Active

Product Category: PCB Headers and

Receptacles



Documents & Resources

Drawings

Drawing 462071008_sd.pdf
Packaging Design Drawing PK-46207-001-000.pdf

3D Models and Design Files

3D Model 462071008_stp.zip Symbol Footprint Data SYM-46207-1008-001.zip

Specifications

Product Specification PS-5556-004-001.pdf
Product Specification PS-45750-001-001.pdf
Product Specification 55560004-PS-ES-000.pdf
Product Specification 55560004-PS-SK-000.pdf
Product Specification 55560004-PS-CH-000.pdf

Product Environment Compliance

Compliance

| GADSL/IMDS | Not Relevant |
|--------------------|--|
| China RoHS | © |
| EU ELV | Not Relevant |
| Low-Halogen Status | Low-Halogen per IEC 61249-2-21 |
| REACH SVHC | Not Contained per D(2023)3788-DC (14 Jun 2023) |
| EU RoHS | Compliant per EU 2015/863 |

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

| Status | Active |
|----------------|---|
| Category | PCB Headers and Receptacles |
| Series | 46207 |
| Description | 4.20mm Pitch, Mini-Fit Jr. Reflow Solder Capable Header, Dual Row, Vertical, 8 Circuits, 1.57mm PCB Thickness, without PCB Pegs, LCP Housing, with Tin (Sn) Over Nickel (Ni) Plating, Glow-Wire Capable, Tray |
| Application | Board-to-Board, Power, Wire-to- Board |
| Comments | Current for wire-to-wire applications = 13.0A max. per circuit; Current for wire-to-board applications = 9.0A max. per circuit |
| Component Type | PCB Header |
| Product Family | Mini-Fit Family Power Connectors |
| Product Name | Mini-Fit Jr. |
| UPC | 883906044541 |

Agency

| CSA | LR19980 |
|-----|---------|
| UL | E29179 |

Electrical

| Current - Maximum per Contact | 13.0A |
|-------------------------------|-------|
| | |

| Voltage - Maximum | 600V AC (RMS)/DC |
|-------------------|------------------|
|-------------------|------------------|

Physical

| Breakaway | No |
|--------------------------------|--------------------------------|
| Circuits (Loaded) | 8 |
| Circuits (maximum) | 8 |
| Color - Resin | Black |
| Durability (mating cycles max) | 100 |
| First Mate / Last Break | No |
| Flammability | 94V-0 |
| Glow-Wire Capable | Yes |
| Guide to Mating Part | No |
| Lock to Mating Part | Yes |
| Material - Metal | Brass |
| Material - Plating Mating | Matte Tin |
| Material - Plating Termination | Matte Tin |
| Material - Resin | High Temperature Thermoplastic |
| Net Weight | 2.986/g |
| Number of Rows | 2 |
| Orientation | Vertical |
| Packaging Type | Tray |
| PC Tail Length | 3.66mm |
| PCB Locator | Yes |
| PCB Retention | Yes |
| PCB Thickness - Recommended | 1.57mm |
| Pitch - Mating Interface | 4.20mm |
| Pitch - Termination Interface | 4.20mm |
| Polarized to Mating Part | Yes |
| Polarized to PCB | Yes |
| Shrouded | Fully |
| Stackable | No |
| Temperature Range - Operating | -40° to +105°C |
| Termination Interface Style | Through Hole |

Solder Process Data

| Max-Duration | 30 |
|------------------------------|----------|
| Lead-Free Process Capability | SMC&WAVE |
| Max-Cycle | 3 |
| Max-Temp | 265 |

Mates With / Use With

Mates with Part(s)

| Description | Part Number |
|--|---------------|
| Mini-Fit TPA2 and Mini-Fit Sigma Dual Row Receptacle Housings | <u>172708</u> |
| Mini-Fit Jr. Receptacle Housings | <u>5557</u> |

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